onsemi

<u>MOSFET</u> – Power, Single N-Channel, DFN5/DFNW5 60 V, 1.3 mΩ, 250 A

NVMFS5H600NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUWI RATINGS (1 J = 25°C unless otherwise noted)							
Parameter			Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	60	V		
Gate-to-Source Voltage	e		V _{GS}	±20	V		
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	Ι _D	250	А		
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		160			
Power Dissipation		T _C = 25°C	PD	160	W		
R _{θJC} (Note 1)		T _C = 100°C		63			
Continuous Drain	Steady State	T _A = 25°C	۱ _D	35	А		
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		22			
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.3	W		
R _{θJA} (Notes 1, 2)		T _A = 100°C		1.3			
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	900	А		
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to + 175	°C		
Source Current (Body Diode)			۱ _S	170	А		
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 26 A)			E _{AS}	338	mJ		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C		

MAXIMUM RATINGS (T₁ = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

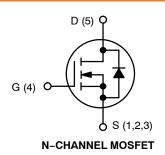
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.80	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	38	

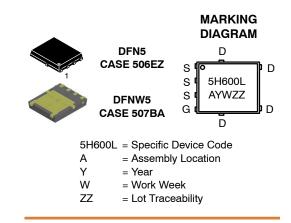
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
Maximum surrent for pulses as long as 1 accord in higher but is do

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	1.3 m Ω @ 10 V	250 A
00 V	1.7 m Ω @ 4.5 V	250 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

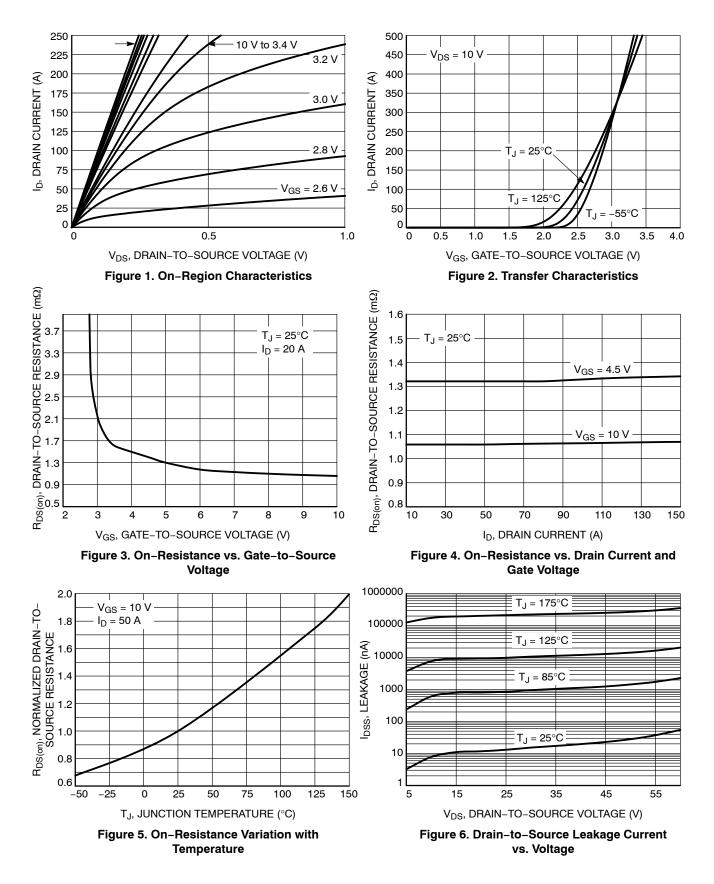
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ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

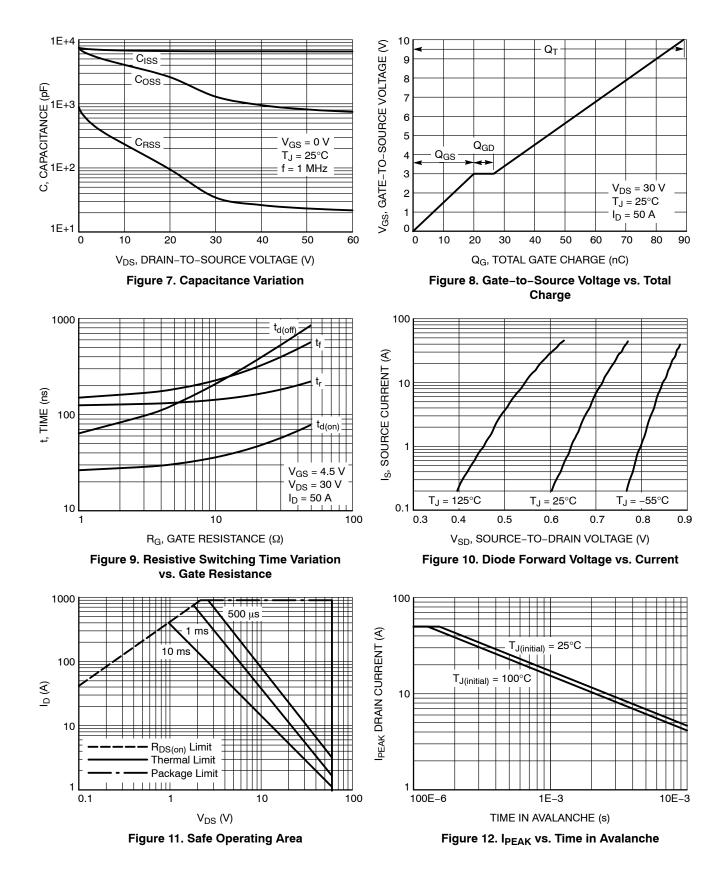
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				34.3		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25 °C			10	μA
			T _J = 125°C			250	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= 250 μA	1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.0		mV/°0
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		1.1	1.3	mΩ
		V _{GS} = 4.5 V	I _D = 50 A		1.4	1.7	
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 50 A			280		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}			6680		pF	
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 30 V			1230		
Reverse Transfer Capacitance	C _{RSS}				30		
Output Charge	Q _{OSS}	$V_{GS} = 0 \text{ V}, V_{DD} = 30 \text{ V}$ $V_{GS} = 4.5 \text{ V}, V_{DS} = 30 \text{ V}; \text{ I}_{D} = 50 \text{ A}$ $V_{GS} = 10 \text{ V}, V_{DS} = 30 \text{ V}; \text{ I}_{D} = 50 \text{ A}$			100		nC V
Total Gate Charge	Q _{G(TOT)}				40		
Total Gate Charge	Q _{G(TOT)}				89		
Threshold Gate Charge	Q _{G(TH)}	V_{GS} = 4.5 V, V_{DS} = 30 V; I_{D} = 50 A			11		
Gate-to-Source Charge	Q _{GS}				20		
Gate-to-Drain Charge	Q _{GD}				6.5		
Plateau Voltage	V _{GP}				3.0		
SWITCHING CHARACTERISTICS (Note 9	ō)						
Turn-On Delay Time	t _{d(ON)}				28		-
Rise Time	t _r	V _{GS} = 4.5 V, V	= 30 V,		130		
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 50 \text{ A}, \text{ R}_G = 2.5 \Omega$			88		- ns
Fall Time	t _f				160		
DRAIN-SOURCE DIODE CHARACTERIS	STICS				•		
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$		0.77	1.2	v
			T _J = 125°C		0.63		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 50 A			72		
Charge Time	t _a				36		ns
Discharge Time	t _b				36		1
Reverse Recovery Charge	Q _{RR}				60		nC

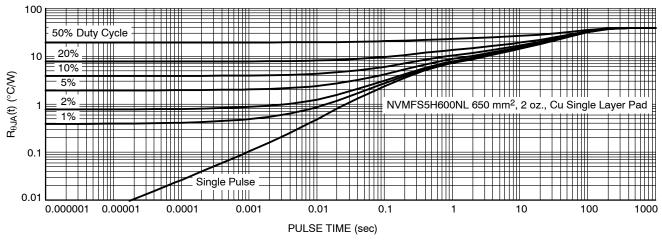
performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





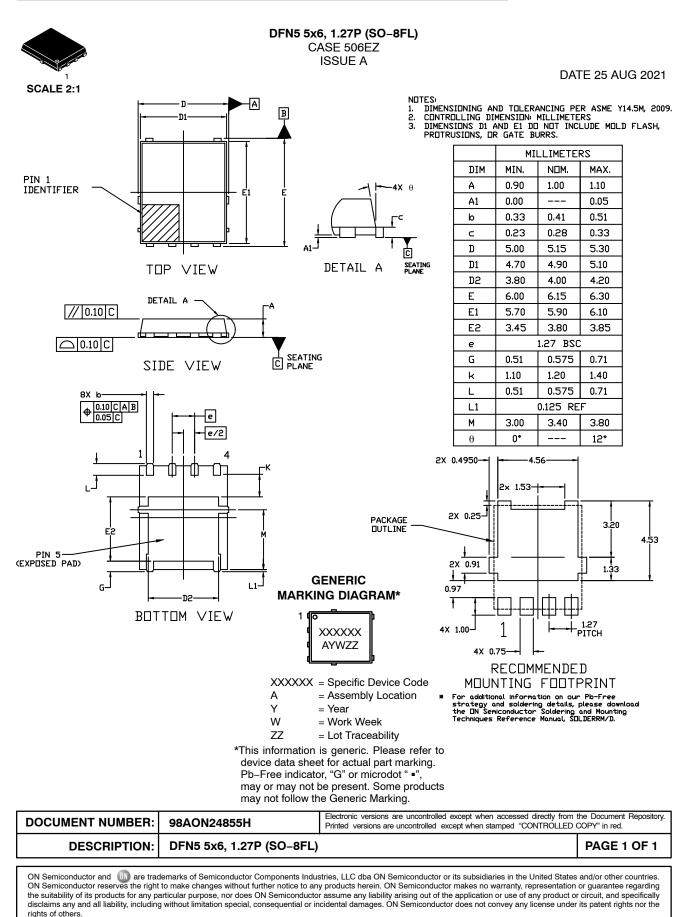


DEVICE ORDERING INFORMATION

Device	Case	Marking	Package	Shipping [†]
NVMFS5H600NLT1G	506EZ	5H600L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5H600NLT3G	506EZ	5H600L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5H600NLWFT1G	507BA	600LWF	DFNW5 (Pb–Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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